



Parameter	Rating	Units
Blocking Voltage	230	V <sub>P</sub>
Load Current	450	mA <sub>DC</sub> /mA <sub>rms</sub>
On-Resistance (max)	4	Ω

### Features

- Integrated Active Current-Limit Protection
- Thermal Shutdown
- High Surge Capability
- Linear AC or DC Operation
- Low Power Consumption
- Clean, Bounce-free Switching
- Low Power Drive Requirements

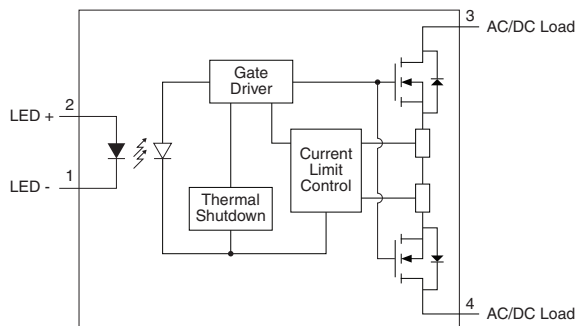
### Applications

- Instrumentation
- Elevator Load Control
- Fire Panels
- Security (alarms, horns, buzzers)
- Industrial Controls
- Medical Equipment
- Peripherals

### Approvals

- UL 508 Certified Component: File E69938

### Block Diagram



Pin #	Name	Description
1	LED -	Negative input to LED
2	LED +	Positive input to LED
3	AC/DC Load	Switch AC/DC terminal
4	AC/DC Load	Switch AC/DC terminal

### Description

CPC1511 is a single-pole, normally open (1-Form-A) optically isolated Solid State Relay with integrated current limit and thermal shutdown features. Perfect for replacing electromechanical relays while enhancing the robustness of wireline-interface applications, the CPC1511 can carry loads up to 450mA<sub>DC</sub>/mA<sub>rms</sub>.

The relay is constructed using an efficient LED for actuation control and an integrated monolithic die for the switch output. The die, fabricated in a high voltage dielectrically isolated technology comprises a photodiode array, switch control with active current limiting and thermal shutdown circuitry, and MOSFET switches.

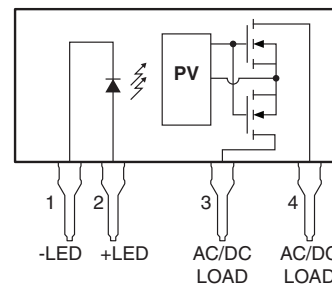
CPC1511 incorporates thermal shutdown circuitry for improved survivability in harsh environments, and is designed to pass regulatory voltage surge requirements when provided with appropriate over voltage protection circuitry.

Designed specifically for environmentally demanding AC or DC applications where printed circuit board space is at a premium and additional power supplies are not available, the CPC1511 is an ideal solution.

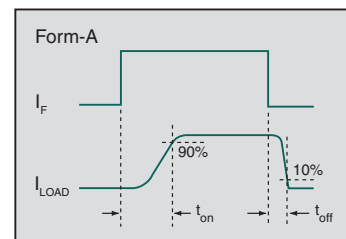
### Ordering Information

Part #	Description
CPC1511Y	4-Pin (8-Pin Body) Power SIP Package (25/Tube)

### Pin Configuration



### Switching Characteristics of Normally Open Devices



### Absolute Maximum Ratings @ $T_A=25^{\circ}\text{C}$

Parameter	Ratings	Units
Blocking Voltage ( $V_{\text{DRM}}$ )	230	$V_P$
Reverse Input Voltage	5	V
Input LED Current		
Continuous	50	mA
Peak (10ms)	0.9	A
Input Power Dissipation <sup>1</sup>	150	mW
Total Power Dissipation <sup>2</sup>	1435	mW
ESD, Human Body Model	4	kV
Isolation Voltage, Input to Output	3750	$V_{\text{rms}}$
Operational Temperature	-40 to +85	$^{\circ}\text{C}$
Storage Temperature	-40 to +125	$^{\circ}\text{C}$

<sup>1</sup> Derate linearly 1.33 mW/ $^{\circ}\text{C}$   
<sup>2</sup> Derate output linearly 14.3 mW/ $^{\circ}\text{C}$

Absolute maximum electrical ratings are at  $25^{\circ}\text{C}$  unless otherwise specified.

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

### Electrical Characteristics @ $T_A=25^{\circ}\text{C}$

Unless otherwise specified, minimum and maximum values are guaranteed by production testing at  $25^{\circ}\text{C}$  only.

Typical values are characteristic of the device at  $25^{\circ}\text{C}$ , and are the result of engineering evaluations. They are provided for informational purposes only, and are not part of the manufacturing testing requirements.

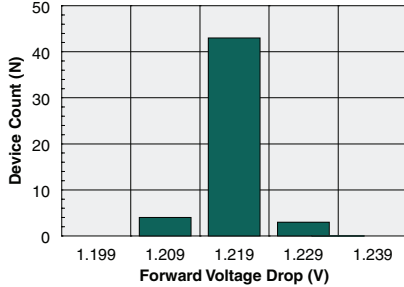
Operating temperature range:  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .

Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Current Limit	$I_F=5\text{mA}$ , $V_L=\pm 10\text{V}$ , $t=2\text{ms}$	$I_{\text{LMT}}$	0.7	-	1.4	A
On-Resistance <sup>1</sup>	$I_F=5\text{mA}$ , $I_L=100\text{mA}$	$R_{\text{ON}}$	-	2.9	4	$\Omega$
	$I_F=5\text{mA}$ , $I_L=500\text{mA}$		-	2.8	4	
Off-State Leakage Current	$V_F=0\text{V}$ , $V_L=230\text{V}$	$I_{\text{LEAK}}$	-	-	1	$\mu\text{A}$
Switching Speeds						
Turn-On	$I_F=5\text{mA}$ , $I_L=100\text{mA}$ , $V_L=10\text{V}$	$t_{\text{on}}$	-	0.7	4	ms
Turn-Off		$t_{\text{off}}$	-	0.11	2	
Output Capacitance	$I_F=0\text{mA}$ , $V_L=1.0\text{V}$ , $f=1\text{MHz}$	$C_O$	-	230	-	pF
<b>Input Characteristics</b>						
Input Control Current to Activate <sup>2</sup>	$I_L=100\text{mA}$	$I_F$	-	1.3	2.5	mA
Input Control Current to Deactivate	$I_L=1\mu\text{A}$		0.2	-	-	
LED Forward Voltage	$I_F=5\text{mA}$	$V_F$	0.9	1.22	1.5	V
<b>Common Characteristics</b>						
Input to Output Capacitance	$f=1\text{MHz}$	$C_{\text{IO}}$	-	1	-	pF
<b>Thermal Characteristics</b>						
Thermal Shutdown	-	$T_{\text{SD}}$	120	132	140	$^{\circ}\text{C}$
Thermal Impedance (Junction to Ambient)	-	$\theta_{\text{JA}}$	-	70	-	$^{\circ}\text{C/W}$
Thermal Characterization Parameter (Junction to Top)	-	$\Psi_{\text{JT}}$	-	13	-	$^{\circ}\text{C/W}$

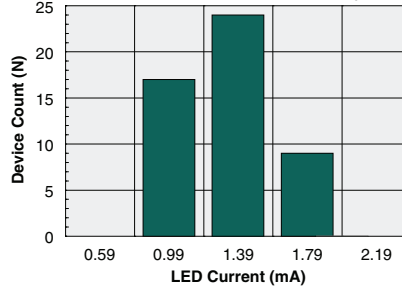
<sup>1</sup> Measurement taken within 1 second of on-time.  
<sup>2</sup> In noisy environments or for  $T_A > 60^{\circ}\text{C}$ , an input control current of 5mA is recommended.

PERFORMANCE DATA\*

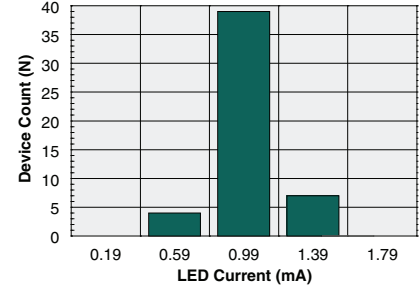
LED Forward Voltage Drop Distribution  
(N=50, I<sub>F</sub>=5mA)



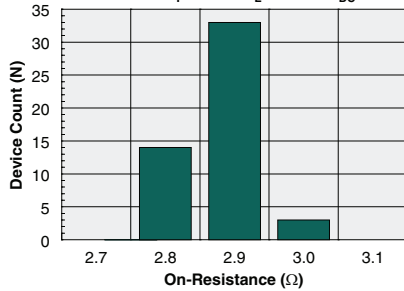
Typical I<sub>F</sub> for Switch Operation  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



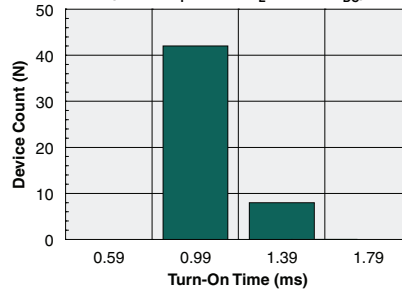
Typical I<sub>F</sub> for Switch Dropout  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



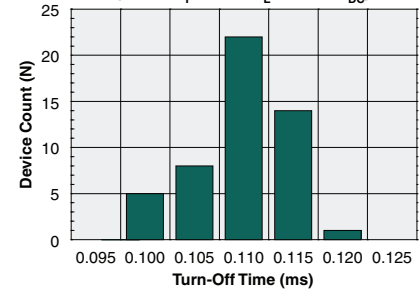
Typical On-Resistance Distribution  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



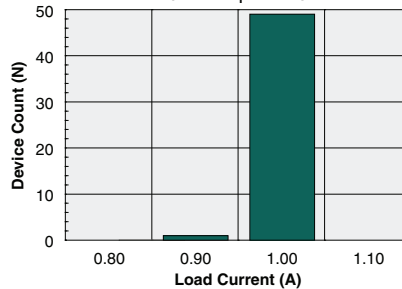
Typical Turn-On Time Distribution  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



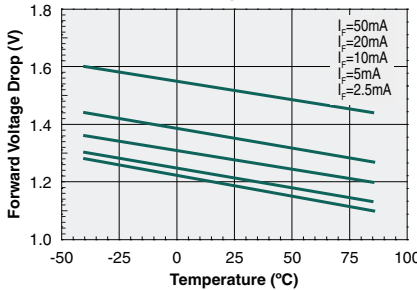
Typical Turn-Off Time Distribution  
(N=50, I<sub>F</sub>=5mA, I<sub>L</sub>=100mA<sub>DC</sub>)



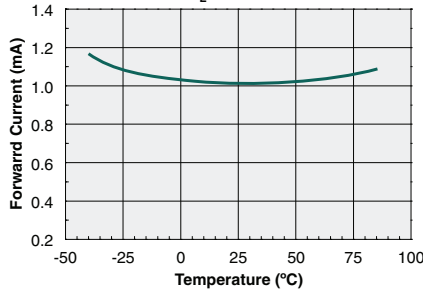
Typical Current Limit Distribution  
(N=50, I<sub>F</sub>=5mA)



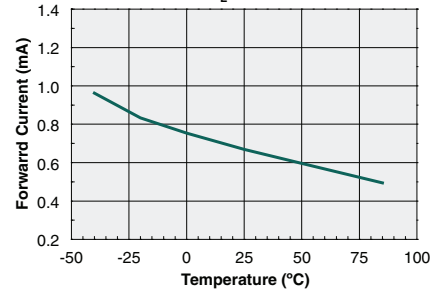
LED Forward Voltage Drop vs. Temperature



Typical I<sub>F</sub> for Switch Operation vs. Temperature  
(I<sub>L</sub>=100mA)

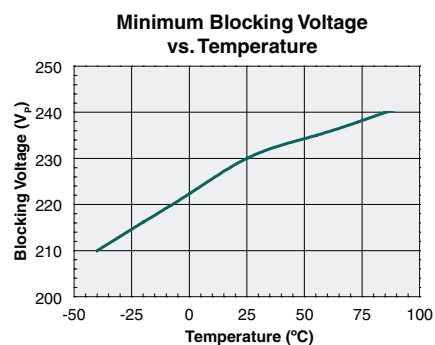
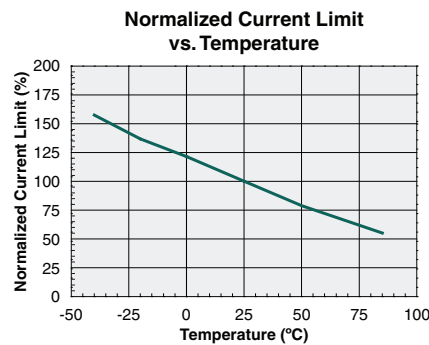
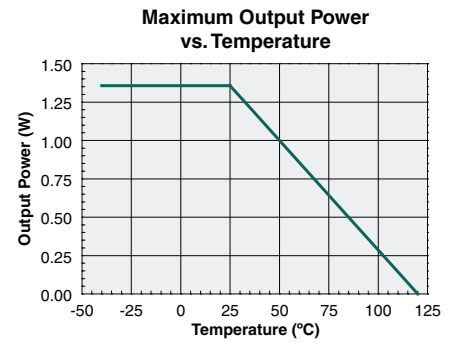
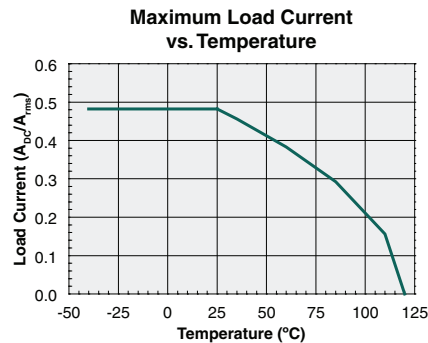
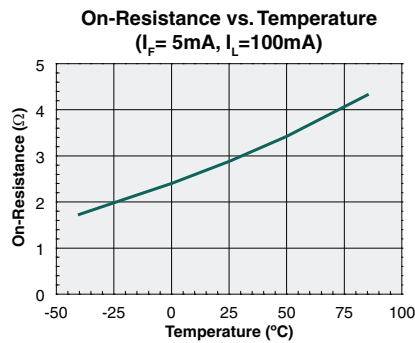
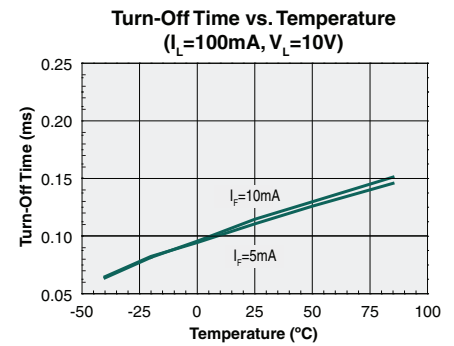
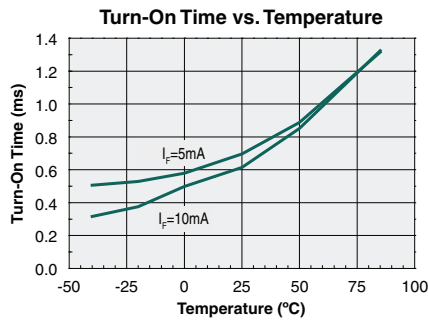
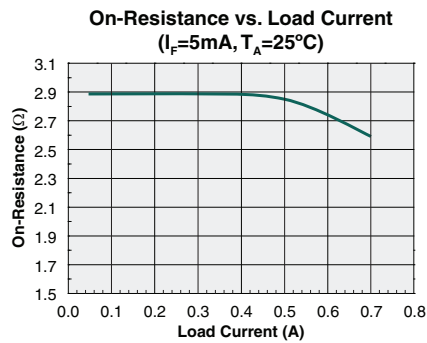
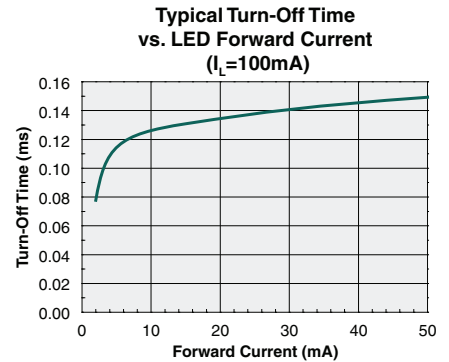
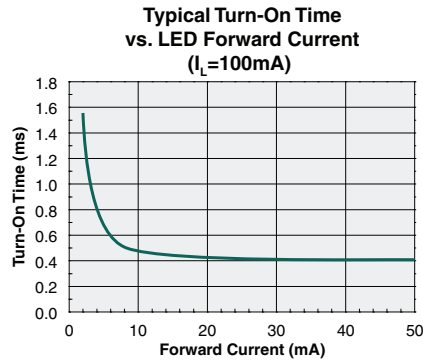
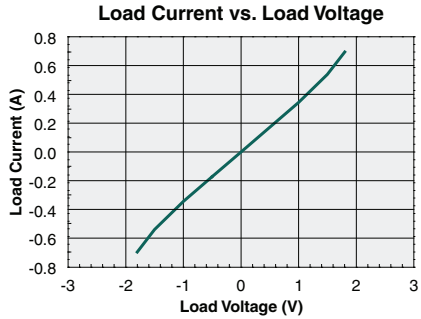


Typical I<sub>F</sub> for Switch Dropout vs. Temperature  
(I<sub>L</sub>=1μA)



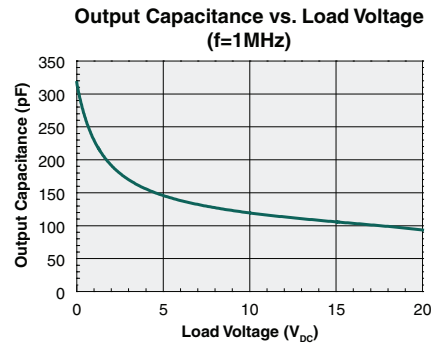
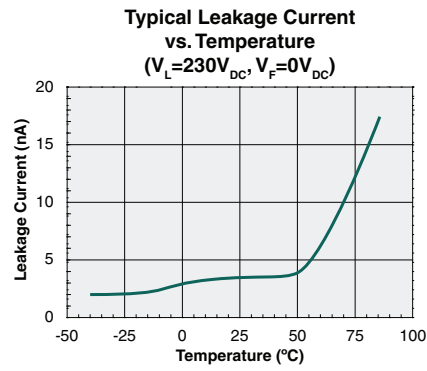
\*The Performance data shown in the graphs above is typical of device operation. Unless otherwise noted, data is presented at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**PERFORMANCE DATA\***



\*The Performance data shown in the graphs above is typical of device operation. Unless otherwise noted, data is presented at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**PERFORMANCE DATA\***



\*The Performance data shown in the graphs above is typical of device operation. Unless otherwise noted, data is presented at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.

## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1511Y	MSL 1

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Soldering Profile

Provided in the table below is the Classification Temperature ( $T_C$ ) of this product and the maximum dwell time the body temperature of this device may be ( $T_C - 5$ )°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature ( $T_C$ )	Dwell Time ( $t_p$ )	Max Reflow Cycles
CPC1511Y	245°C	30 seconds	1

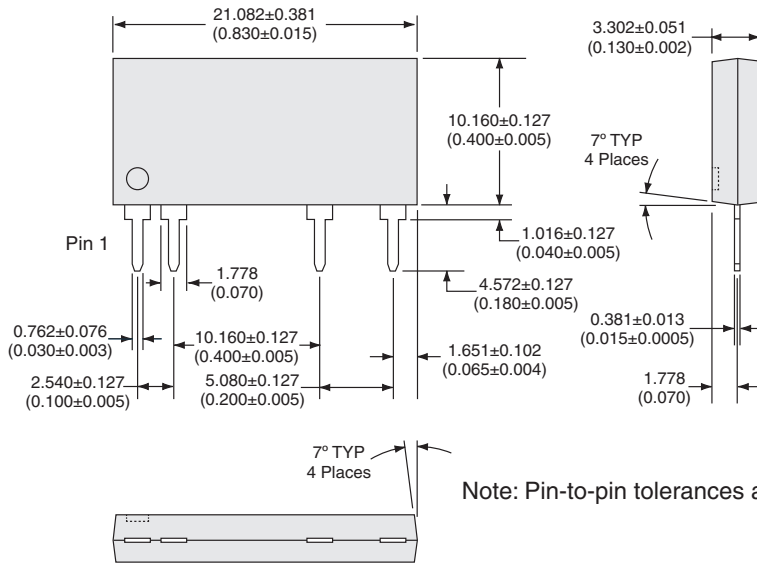
### Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.

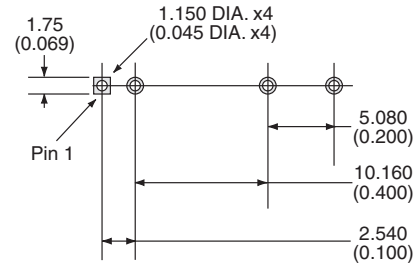


### Mechanical Dimensions

#### CPC1511Y Package



#### PCB Hole Pattern



Dimensions  
mm  
(inches)

For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.

The information below supercedes any previously presented material.

For additional information please visit our website at: <https://www.littelfuse.com>



---

Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at [www.littelfuse.com/disclaimer-electronics](http://www.littelfuse.com/disclaimer-electronics).